Systems Engineering and Modeling at Start-Up Company

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Abstract

We have been assisting in applying Systems Engineering techniques and methods in a small (tens of persons) start-up company in the semiconductor process and equipment market. We report our observations in this start-up company with an innovative product operating in a dynamic environment. Start-up companies in general explore new applications or new technologies: an environment full of unknowns, uncertainties and other surprises. In the specific case of semiconductor process and equipment the system is highly multi-disciplinary, amongst others: high precision mechanical, control, optics, chemical, signal processing, and power electronics.

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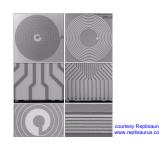
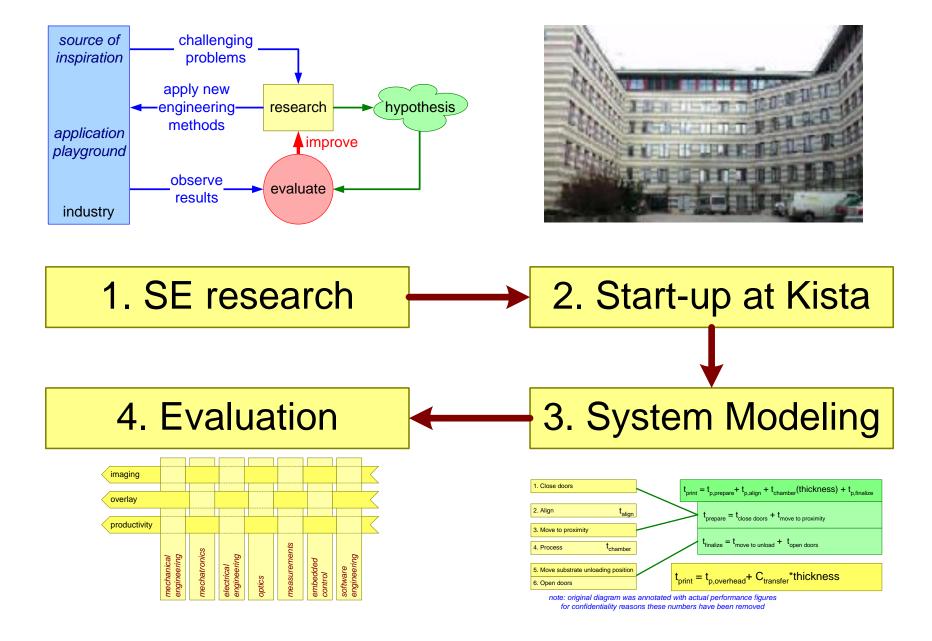
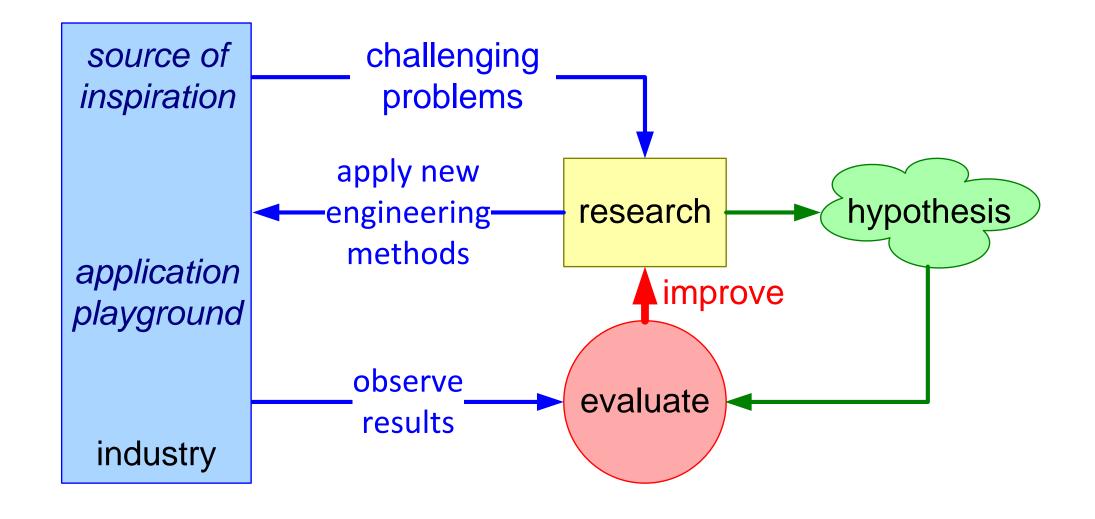


Figure Of Contents™





Industry as Laboratory





Industry as Laboratory (2)

SubSea

intended dissemination and research partners Kongsberg Industry Domains

Defence

Manufacturing

Maritime

generalization and consolidation to facilitate use in other domains

single domain research focus on industrial problem

multi-domain research and expertise

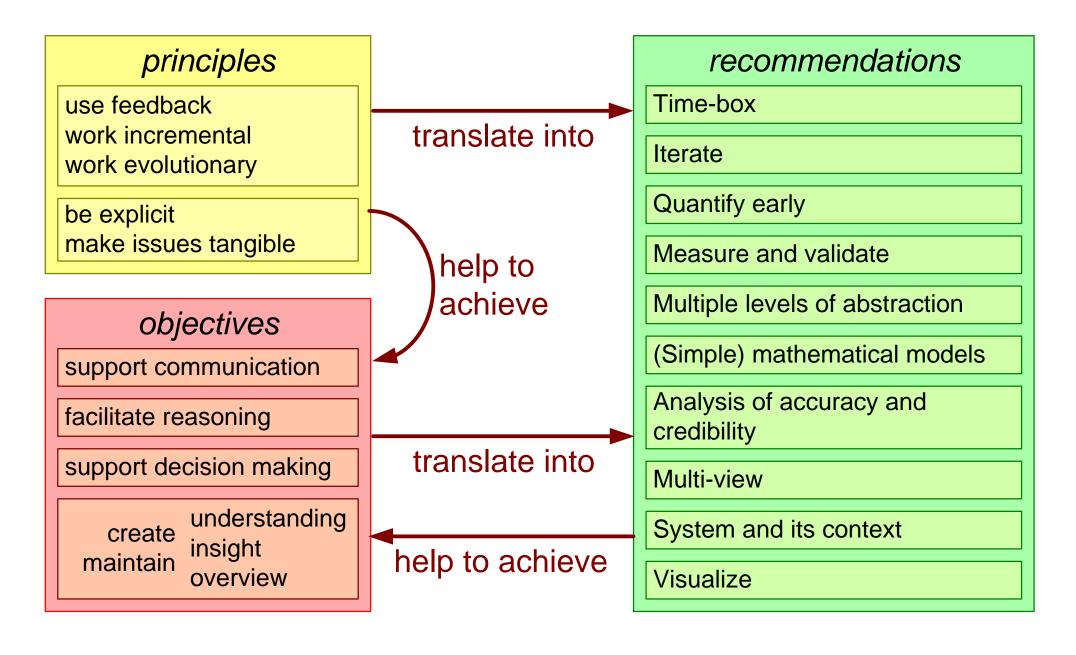
Reliability /Robustness in harsh environments

Innovation /
Responsiveness
for change



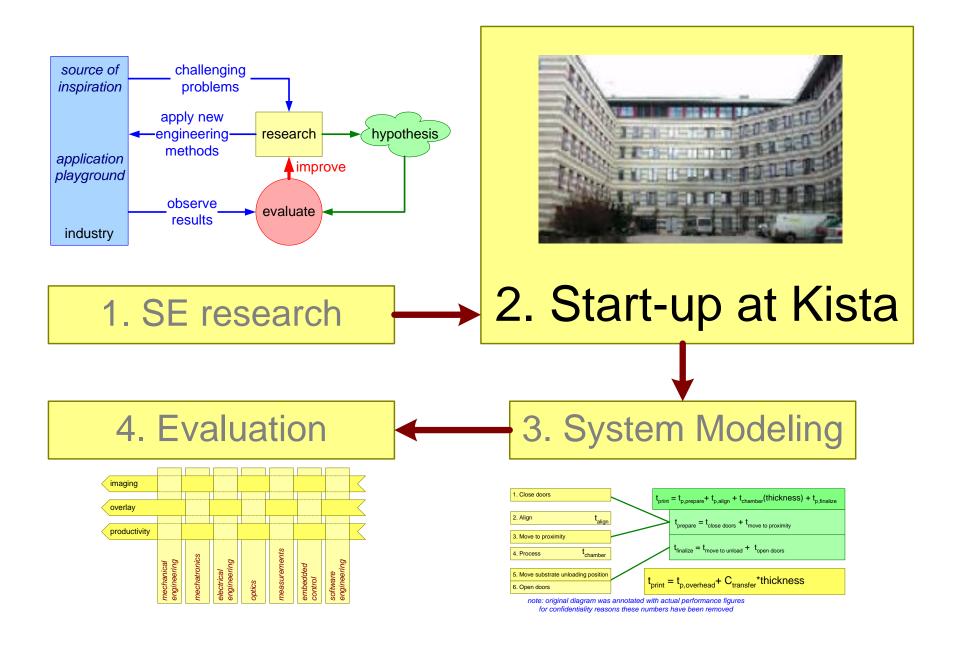


Modeling Recommendations as Applied



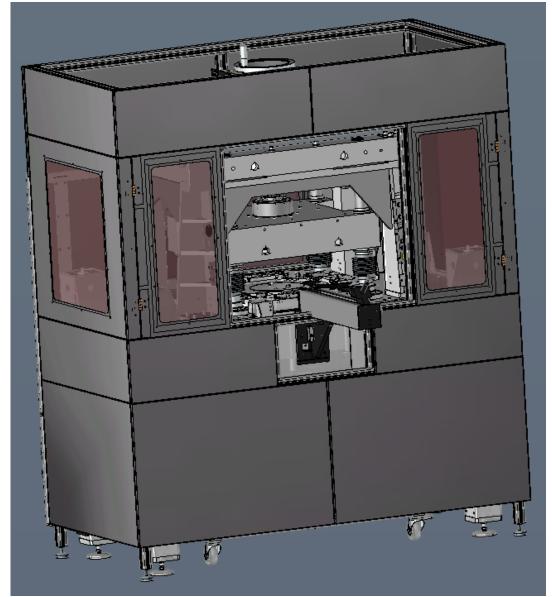


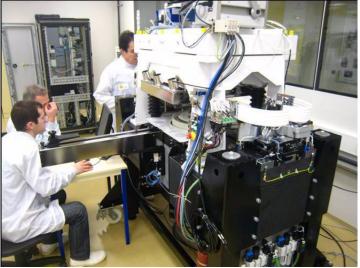
Start-Up Company Replisaurus in Kista (Sweden)



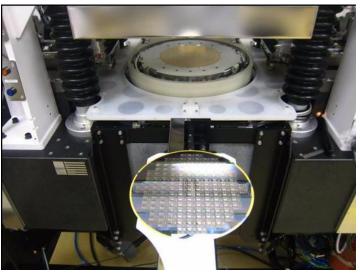


The Copper Printer

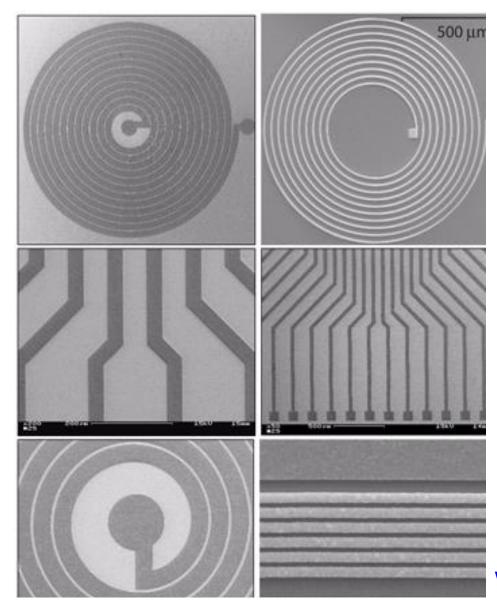




courtesy Replisaurus www.replisaurus.com



Example of printed copper structures

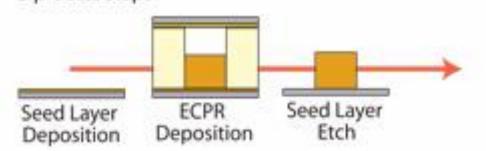


courtesy Replisaurus www.replisaurus.com

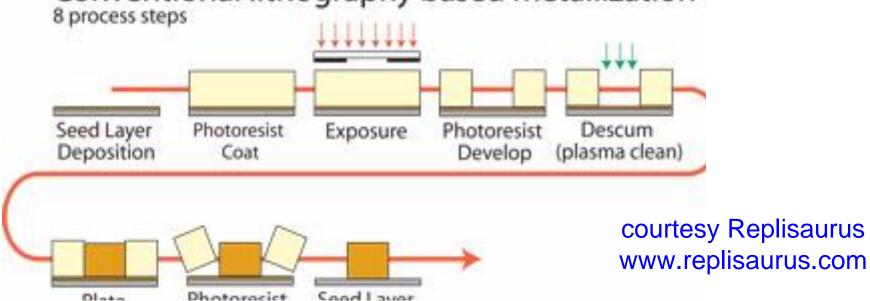


ECPR technology replaces 6 process steps by 1 step



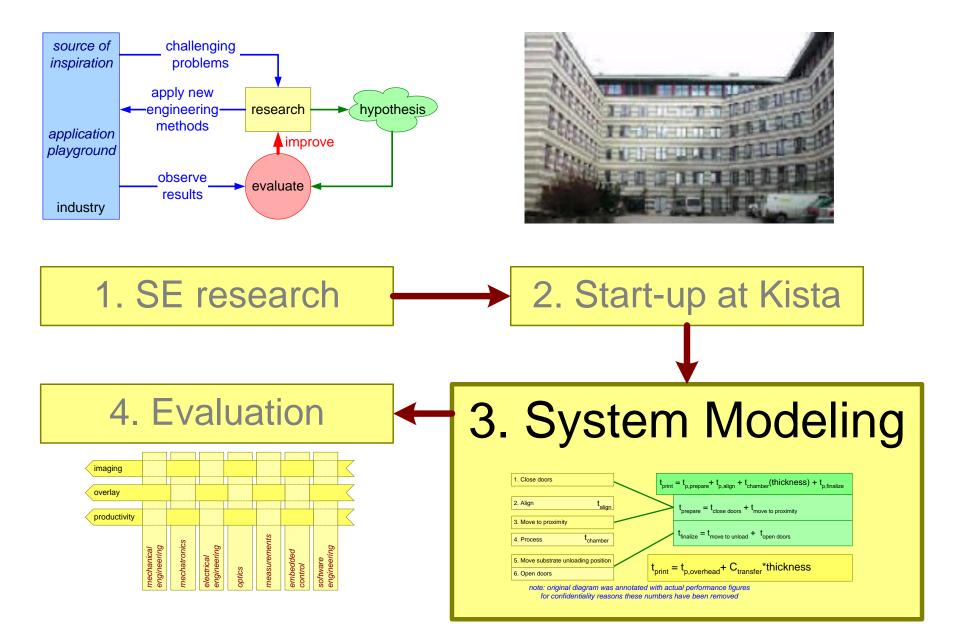


Conventional lithography based metallization



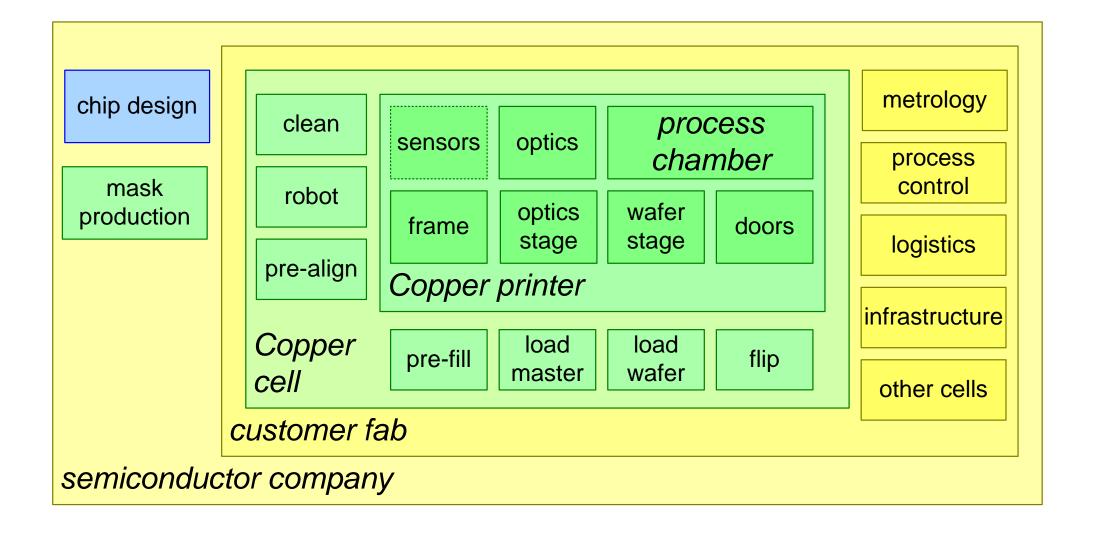


System Modeling



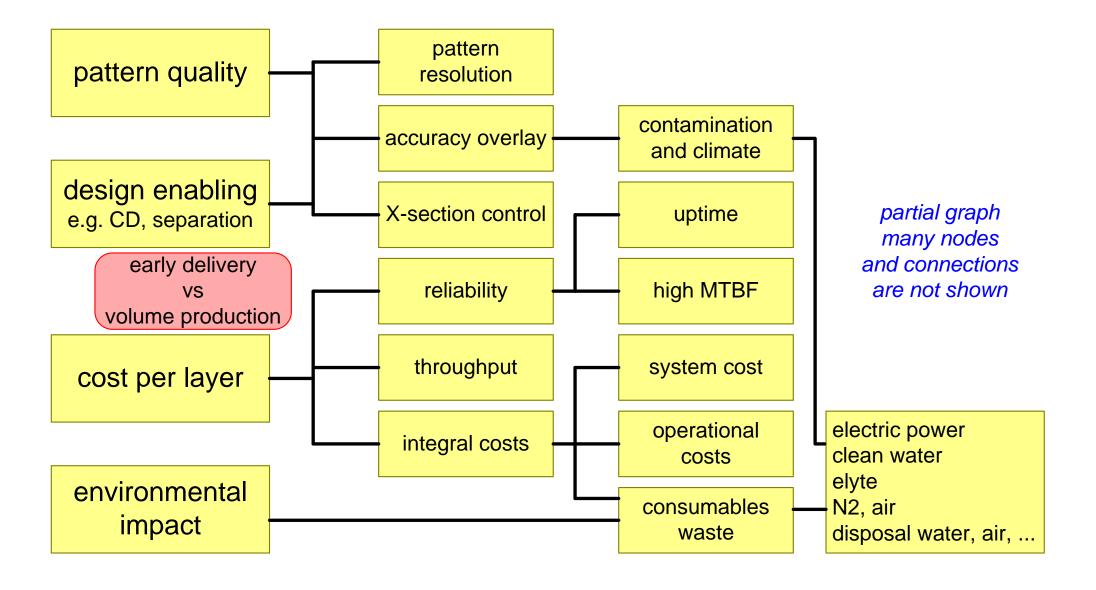


Overview of the different scopes





Customer key driver graph





Process flow at fab level, from inspection until testing

	throughput in minutes	wafer	FOUP	
wafer	1. inspection			
seed wafer	2. seed sputter	1	25	
Cu wafer	3. Cu print	2	50	target spec
wafer	4. seed etch	1	20	
spin coated polymer	dual layer only			
wafer	5. coat/develop dielectrics	34	50	75100??
wafer	6. exposure or CMP for polymer vias	12	30	
	7. E-test			

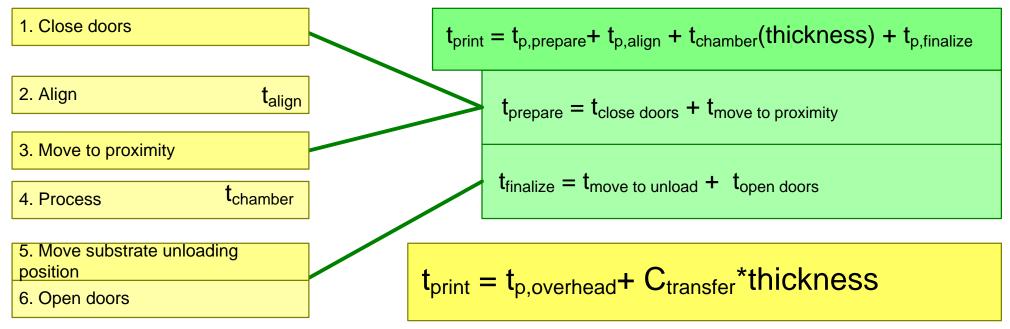


Work flow in the Copper Printer

- 0. Loading Master&substrate
- 1. Close doors
- 2. Align
- 3. Move to proximity
- 4. Process incl. rinse&dry
- 5. Move substrate unloading position
- 6. Open doors
- 7. Unloading Master&substrate



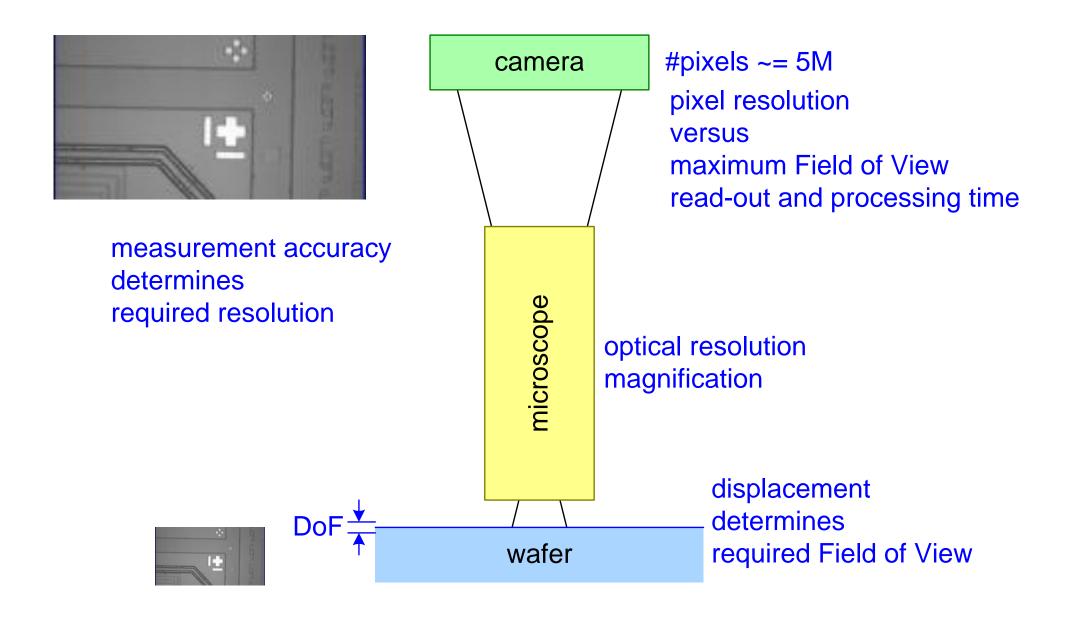
Formula of printer throughput time



note: original diagram was annotated with actual performance figures for confidentiality reasons these numbers have been removed

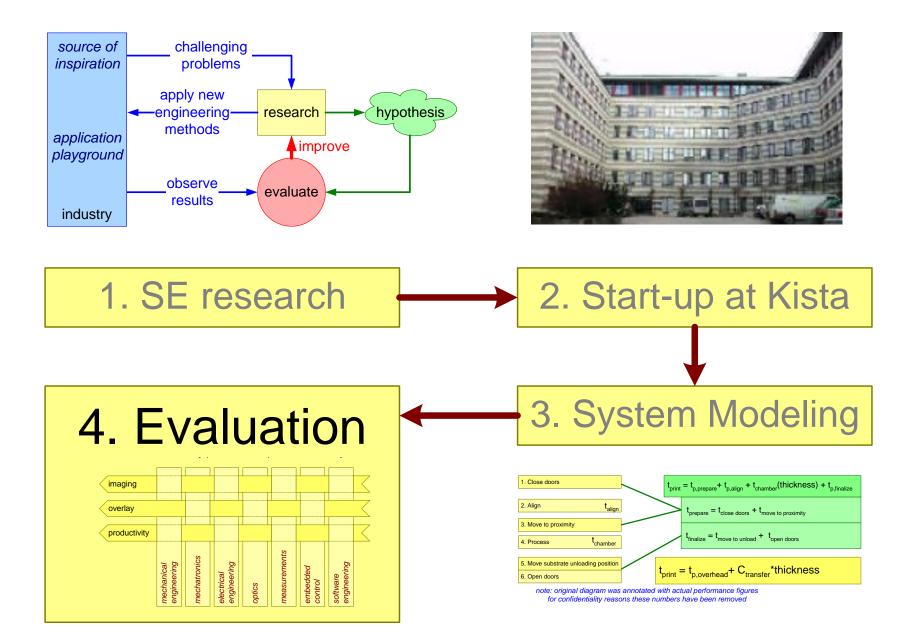


Optical path to measure marker position





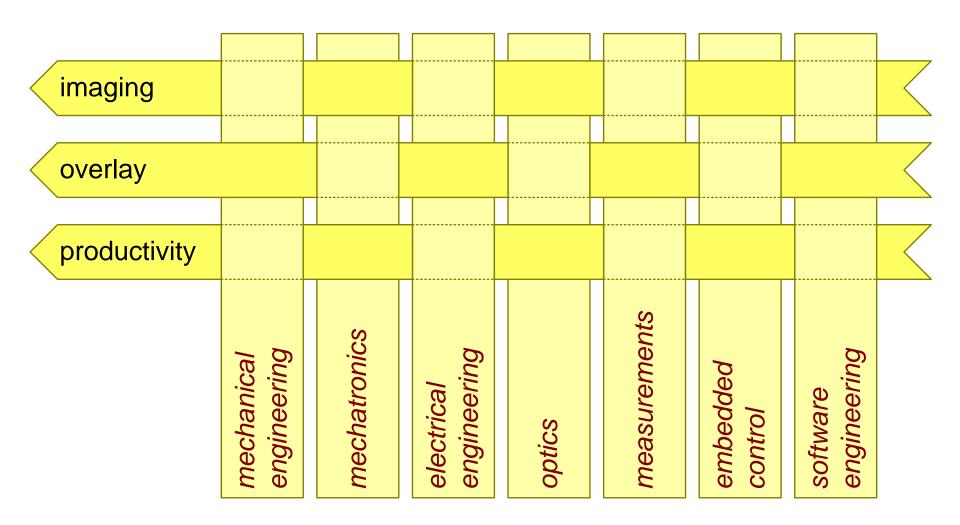
Evaluation





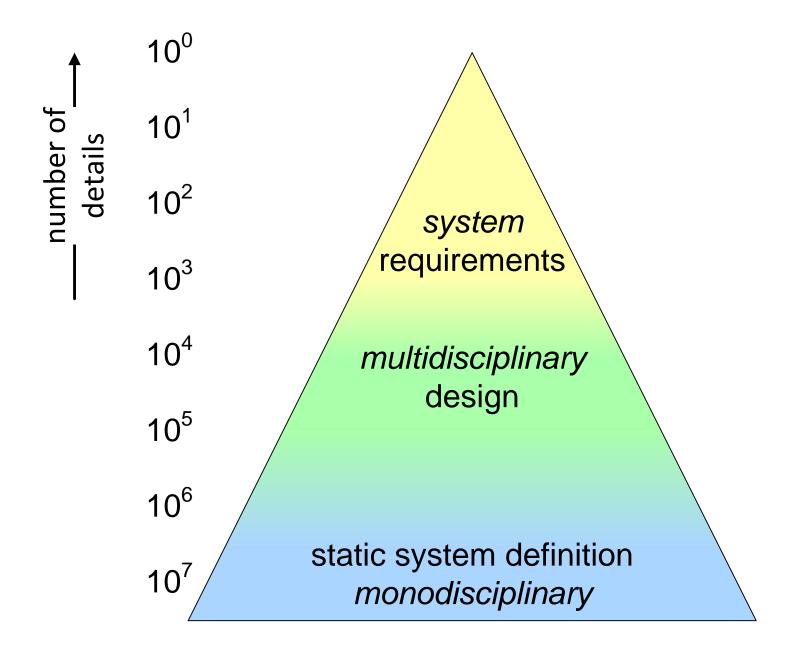
From Engineering Disciplines to System Qualities

Systems Engineering: responsible for customer key drivers and key performance parameters of system



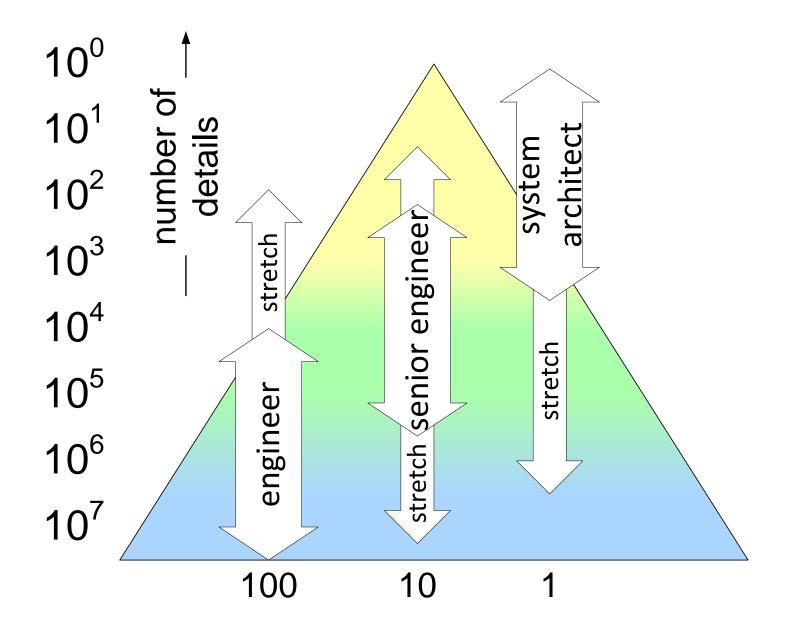


Levels of Abstraction





Lifting Engineers to System Concerns





Conclusion SE applicability

Systems Engineering at Start-Up companies is applicable

customization is required to adapt to:

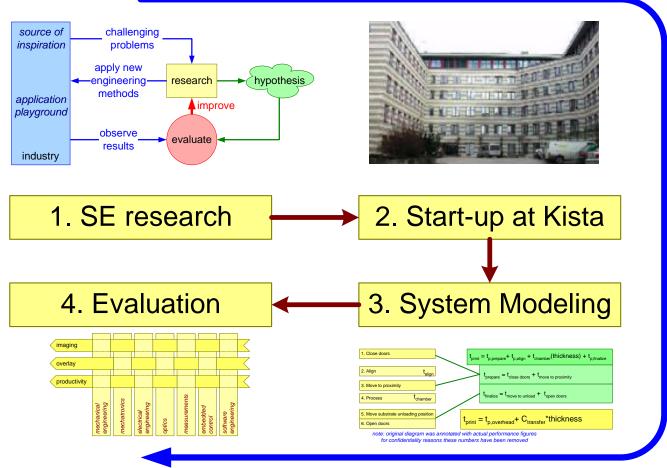
company size

market and technology maturity

system models help to "lift" engineers to system level concerns



Application of theory in practice



is required for learning and validation

